

C308F

3 mm x 8.4 mm fast-acting, ceramic tube fuses for hazardous applications



Product features

A compact 3 mm x 8.4 mm fuse provides a space saving alternative to conventional fuse solutions with high interrupting rating for primary and secondary circuit protection up to 250 Vac/dc and 250 mA

- Meets electrical performance specifications for intrinsically safe (EN60079-11) applications
- Fast-acting, high interrupting rating of 4000 A at 250 Vac/dc
- Ceramic tube, silver plated brass end cap construction
- Optional axial leads (tinned copper axial leads construction)
- RoHS compliant

Agency information

 cURus Recognition file number: E19180, Guide JDYX2/JDYX8

Applications

- · Hazardous environments
- · Petrochemical processing and refining equipment
- · Pulp and paper processing equipment
- · Intrinsically safe network barriers

Packaging

- · Specify part number and packaging suffix.
- · Package suffixes:

Ferrule

- -TR (500 fuses on tape and reel)
- -TR1 (1000 fuses on tape and reel)

Axial leaded

 TR1 (axial leaded version, 1500 fuses on tape and reel)

Ordering

 Specify part number and packaging suffix (e.g., C308F-V-160mA-TR1)



Product specifications

| Part number | | Voltage rating | Color | Interrupting rating @ 250 | Typical DC cold resistance | Typical melting I²T*** | Agency Information |
|-------------|---------------|-------------------|--------|---------------------------|----------------------------|------------------------------|-----------------------|
| Ferrule | Axial lead | Vac/dc | | Vac/dc (A)* | (Ω)** | I ² T*** | cURus |
| C308F40mA | C308F-V-40mA | | Grey | | 14.2 | 0.00006 | Х |
| C308F50mA | C308F-V-50mA | | Red | | 9.40 | 0.00010 | Х |
| C308F63mA | C308F-V-63mA | | Pink | | 8.80 | 0.00012 | Pending |
| C308F80mA | C308F-V-80mA | | Green | | 5.10 | 0.00018 | Х |
| C308F100mA | C308F-V-100mA | 250 | Yellow | 4000 | 2.87 | 0.00087 | Х |
| C308F125mA | C308F-V-125mA | | Orange | | 2.20 | 0.00134 | Х |
| C308F160mA | C308F-V-160mA | | Violet | | 2.05 | 0.00166 | Х |
| C308F200mA | C308F-V-200mA | | Brown | | 1.01 | 0.00237 | Х |
| C308F250mA | C308F-V-250mA | | Black | | 0.71 | 0.00530 | Х |

^{*} AC Interrupting Rating (4000 A, PF = 0.4); DC Interrupting Rating measured at rated voltage, time constant 4 microseconds, battery source.

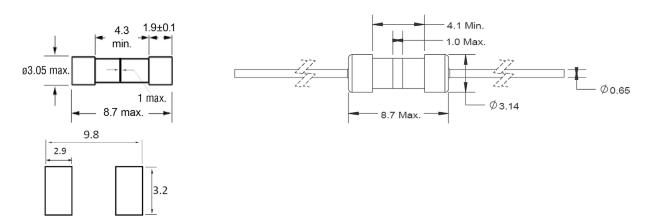
Electrical characteristics

| Amp Rating | % of Amp Rating | Opening Time | |
|----------------|-----------------|--------------------|--|
| | 110% | 4 hours, min | |
| 40 mA ~ 250 mA | 300% | 10 seconds, max | |
| | 1000% | 0.002 seconds, max | |

Environmental data

- Operating temperature: -55 °C to +125 °C (with derating)
- Thermal Shock: MIL-STD-202G, Method 107G (Test Condition 5 cycles -55 °C to 125 °C)
- Resistance to Solder Heat: MIL-STD-202G Method 210F
- Vibration: MIL-STD-202G, Method 201A (10 Hz to 55 Hz) Condition A, "-V" axial leaded version IEC60068-2-6
- Solderability: J-STD-002C, Test Method C1, "-V" axial leaded version IEC60127-2/A3.3
- Component Life Reliability: +125 °C, 500 hours

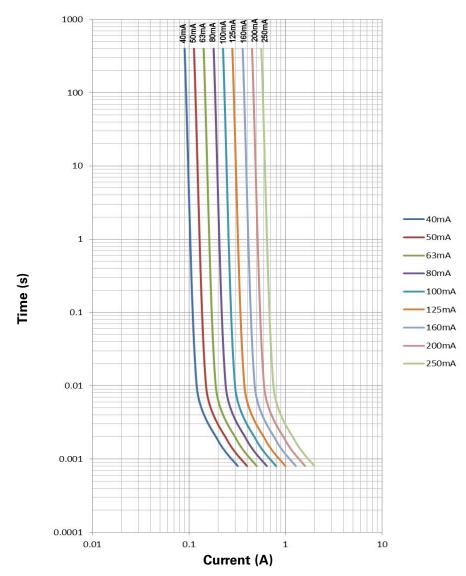
Dimensions-mm



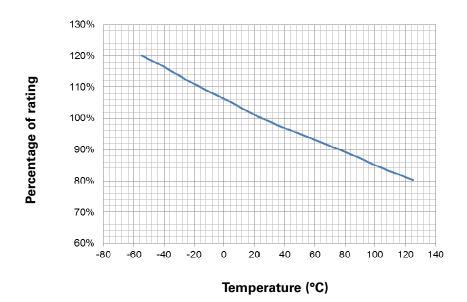
^{**} DC Cold Resistance (Measured at ≤10% of rated current).

^{***} Typical I2t measured at 10In.

Average time-current curves



Temperature derating curve



Surface mounting soldering parameters (Ferrule)

- Reflow solder: JEDEC J-STD-020 $T_c = 250$ °C. $T_p = 30$ s
- Wave and manual solder is not recommended

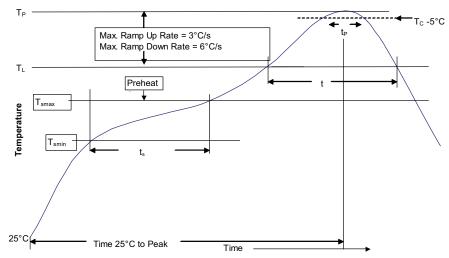


Table 1 - Standard SnPb Solder (T_C)

| Package Thickness | Volume mm3 <350 | Volume mm3 ≥350 |
|----------------------|-----------------------|-----------------------|
| <2.5mm) | 235°C | 220°C |
| ≥2.5mm | 220°C | 220°C |

Table 2 - Lead (Pb) Free Solder (T_c)

| Package Thickness | Volume mm³ <350 | Volume mm³ 350 - 2000 | Volume mm³ >2000 |
|----------------------|-----------------------|-----------------------------|------------------------|
| <1.6mm | 260°C | 260°C | 260°C |
| 1.6 – 2.5mm | 260°C | 250°C | 245°C |
| >2.5mm | 250°C | 245°C | 245°C |

Reference JDEC J-STD-020

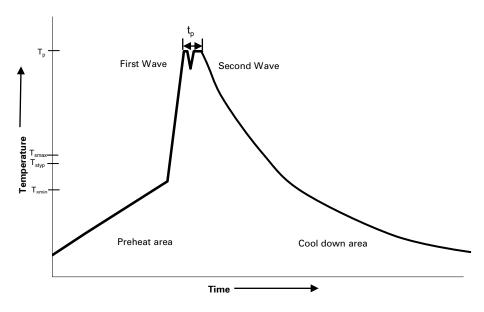
| Profile Feature | Standard SnPb Solder | Lead (Pb) Free Solder | |
|--|--------------------------|--------------------------|--|
| Preheat and Soak • Temperature min. (T _{smin}) | 100 °C | 150 °C | |
| • Temperature max. (T _{smax}) | 150 °C | 200 °C | |
| • Time (T _{Smin} to T _{Smax}) (t _S) | 60-120 Seconds | 60-120 Seconds | |
| Average ramp up rate T_{SMax} to T_p | 3 °C/ Second Max. | 3 °C/ Second Max. | |
| Liquidous temperature (TL) Time at liquidous (tL) | 183 °C 60-150 Seconds | 217 °C 60-150 Seconds | |
| Peak package body temperature (Tp)* | Table 1 | Table 2 | |
| Time (t _p)** within 5 °C of the specified classification temperature (T _C) | 20 Seconds** | 30 Seconds** | |
| Average ramp-down rate (T_p to T_{smax}) | 6 °C/ Second Max. | 6 °C/ Second Max. | |
| Time 25 °C to Peak Temperature | 6 Minutes Max. | 8 Minutes Max. | |

^{*} Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Through hole wave solder profile (Axial lead)

Reflow soldering not recommended



Reference EN 61760-1:2006

| Profile Feature | | Standard SnPb Solder | Lead (Pb) Free Solder | |
|---------------------|--|---|---|--|
| Preheat | • Temperature min. (T _{smin}) | 100°C | 100°C | |
| | • Temperature typ. (T _{styp}) | 120°C | 120°C | |
| | • Temperature max. (T _{smax}) | 130°C | 130°C | |
| | • Time (T _{smin} to T _{smax}) (t _s) | 70 seconds | 70 seconds | |
| Δ preheat to | max Temperature | 150°C max. | 150°C max. | |
| Peak tempera | iture (Tp)* | 235°C – 260°C | 250°C – 260°C | |
| Time at peak | temperature (t _p) | 10 seconds max 5 seconds max each wave | 10 seconds max 5 seconds max each wave | |
| Ramp-down ra | ate | ~ 2 K/s min ~3.5 K/s typ ~5 K/s max | ~ 2 K/s min ~3.5 K/s typ ~5 K/s max | |
| Time 25°C to | 25°C | 4 minutes | 4 minutes | |

Manual solder

350 °C, 4-5 seconds. (by soldering iron), generally manual, hand soldering is not recommended.

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